



深圳市信德意电子有限公司

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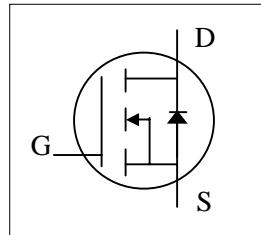
**Advanced Power
Electronics Corp.**

AP9T15GH/J

Pb Free Plating Product

**N-CHANNEL ENHANCEMENT MODE
POWER MOSFET**

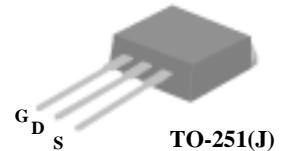
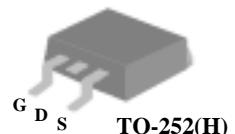
- ▼ Low Gate Charge
- ▼ Capable of 2.5V gate drive
- ▼ Single Drive Requirement
- ▼ RoHS Compliant



BV_{DSS}	20V
$R_{DS(ON)}$	50mΩ
I_D	12.5A

Description

The Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, ultra low on-resistance and cost-effectiveness.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 16	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 4.5V$	12.5	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 4.5V$	8	A
I_{DM}	Pulsed Drain Current ¹	60	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	12.5	W
	Linear Derating Factor	0.1	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Units
R_{thj-c}	Thermal Resistance Junction-case	Max. 10	°C/W
R_{thj-a}	Thermal Resistance Junction-ambient	Max. 110	°C/W



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Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$	20	-	-	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_{\text{D}}=1\text{mA}$	-	0.02	-	$\text{V}/^\circ\text{C}$
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=6\text{A}$	-	-	50	$\text{m}\Omega$
		$V_{\text{GS}}=2.5\text{V}$, $I_{\text{D}}=5.2\text{A}$	-	-	80	$\text{m}\Omega$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$	0.5	-	1.5	V
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{D}}=10\text{A}$	-	10	-	S
I_{DSS}	Drain-Source Leakage Current ($T_j=25^\circ\text{C}$)	$V_{\text{DS}}=20\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	1	uA
	Drain-Source Leakage Current ($T_j=150^\circ\text{C}$)	$V_{\text{DS}}=16\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	25	uA
I_{GSS}	Gate-Source Leakage	$V_{\text{GS}}=\pm 16\text{V}$	-	-	± 100	nA
Q_g	Total Gate Charge ²	$I_{\text{D}}=10\text{A}$	-	5	8	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=16\text{V}$	-	1	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{\text{GS}}=4.5\text{V}$	-	2	-	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time ²	$V_{\text{DS}}=10\text{V}$	-	8	-	ns
t_r	Rise Time	$I_{\text{D}}=10\text{A}$	-	55	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time	$R_G=3.3\Omega$, $V_{\text{GS}}=5\text{V}$	-	10	-	ns
t_f	Fall Time	$R_D=1\Omega$	-	3	-	ns
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$	-	360	580	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=20\text{V}$	-	70	-	pF
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	50	-	pF
R_g	Gate Resistance	$f=1.0\text{MHz}$	-	1.67	-	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_{\text{S}}=10\text{A}$, $V_{\text{GS}}=0\text{V}$	-	-	1.3	V
t_{rr}	Reverse Recovery Time ²	$I_{\text{S}}=10\text{A}$, $V_{\text{GS}}=0\text{V}$,	-	17	-	ns
Q_{rr}	Reverse Recovery Charge	$dI/dt=100\text{A}/\mu\text{s}$	-	9	-	nC

Notes:

1.Pulse width limited by safe operating area.

2.Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.



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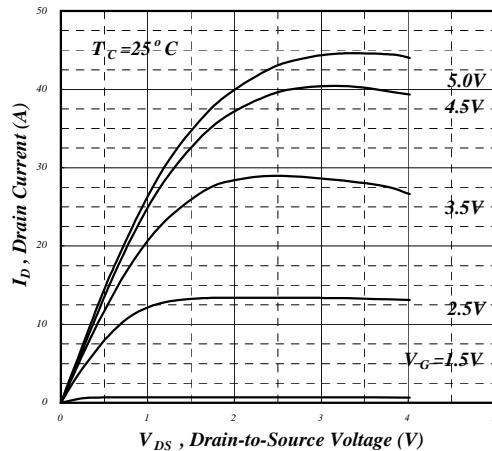


Fig 1. Typical Output Characteristics

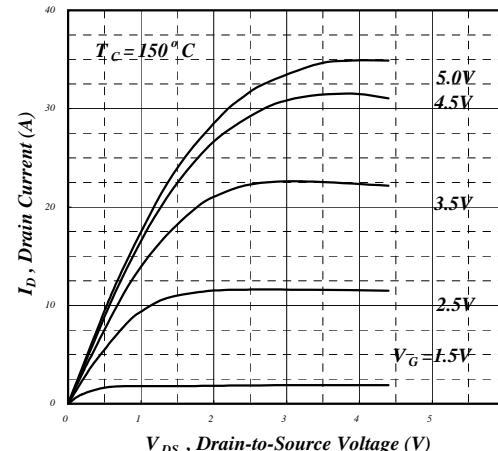


Fig 2. Typical Output Characteristics

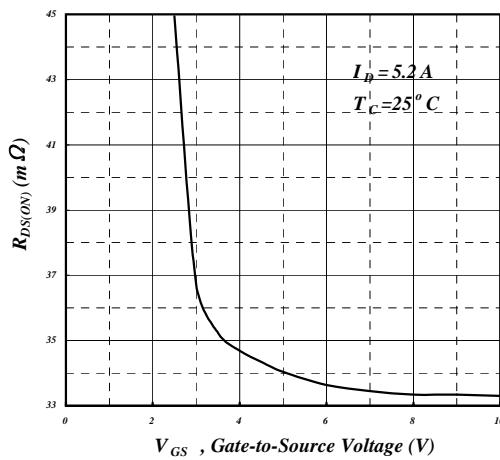


Fig 3. On-Resistance v.s. Gate Voltage

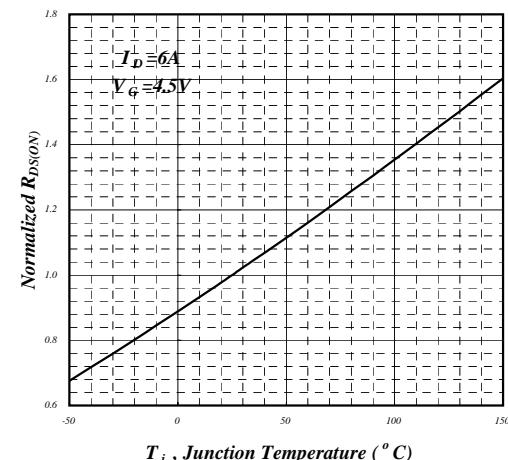


Fig 4. Normalized On-Resistance v.s. Junction Temperature

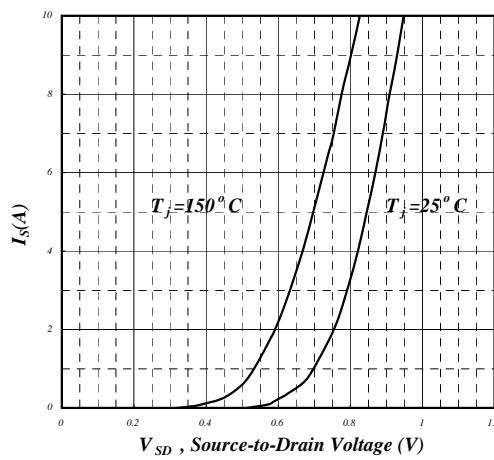


Fig 5. Forward Characteristic of Reverse Diode

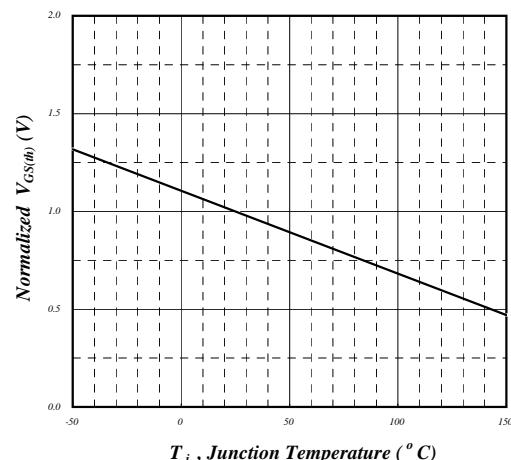


Fig 6. Gate Threshold Voltage v.s. Junction Temperature



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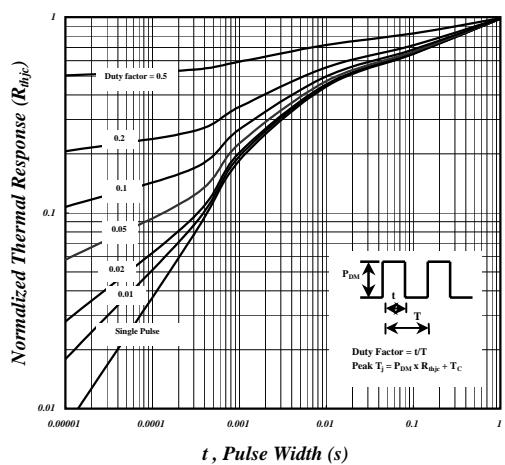
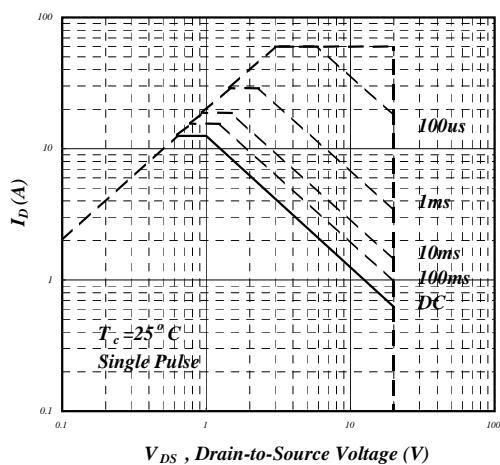
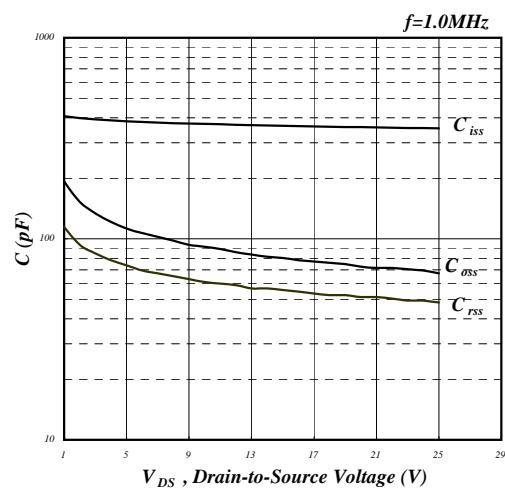
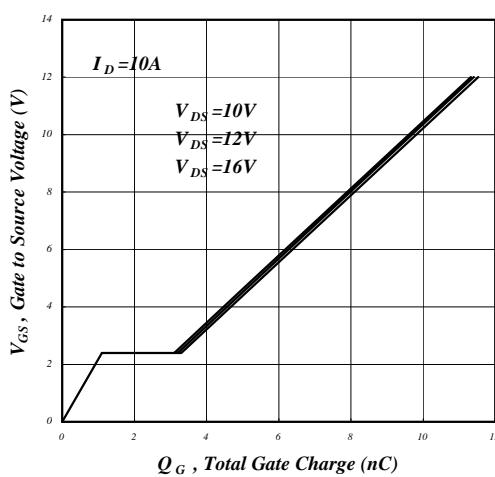


Fig 9. Maximum Safe Operating Area

Fig 10. Effective Transient Thermal Impedance

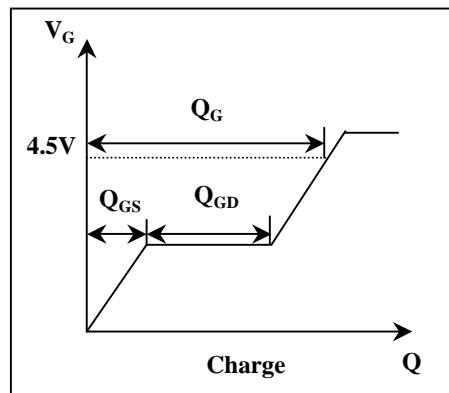
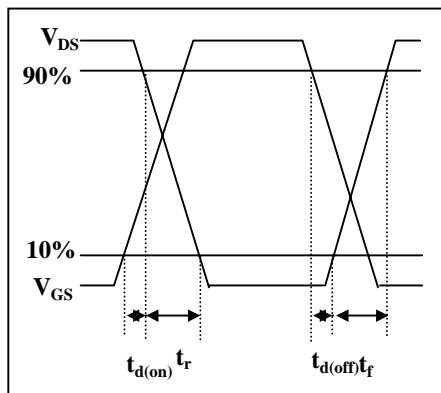


Fig 11. Switching Time Waveform

Fig 12. Gate Charge Waveform